

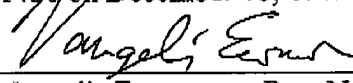
DEC 18 2003

OFFICIAL PATENTDOCKET: CU-2417
Customer No. 26530**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application: Takahiro IJIMA et al.]	
]	
Serial No.: 09/736,864]	GRP ART UNIT : 2815
]	
Filed: December 14, 2000]	Ex.: CHU, C.
]	
For: INTERCONNECTION SUBSTRATE]	
HAVING METAL COLUMNS COVERED BY A]	
RESIN FILM AND MANUFACTURING]	
METHOD THEREOF]	

Certification under 37 C.F.R. §1.8(a)

I hereby certify that this correspondence is being transmitted by facsimile to the United States Patent and Trademark Office at the following facsimile number: (703) 872-9306, to the attention of Examiner C. Chu, and addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on December 18, 2003.


Vangelis Economou, Reg. No. 32,341

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT UNDER 37 CFR § 1.116

Sir:

In response to the Official Action dated October 21, 2003, please amend the above-identified application as follows:

AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in this application: